NSN 5962-01-300-2292

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View Online at https://aerobasegroup.com/nsn/5962-01-300-2292
Overall Height:
Between 0.220 inches and 0.360 inches
Body Length:
Between 2.370 inches and 2.430 inches
Body Width:
Between 0.550 inches and 0.610 inches
Body Height:
Between 0.030 inches and 0.170 inches
Maximum Power Dissipation Rating:
1.5 watts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
End Application:
Receiver set, infrared warning an/aar-44
Features Provided:
Hermetically sealed and burn in and low power and bidirectional and w/enable
Inclosure Material:
Ceramic
Inclosure Configuration:
Dual-in-line
Output Logic Form:
Complementary-metal oxide-semiconductor logic
Input Circuit Pattern:
44 input
Terminal Surface Treatment:
Solder
Voltage Rating And Type Per Characteristic:
-0.5 volts power source and 7.0 volts power source
Time Rating Per Chacteristic:
100.00 nanoseconds propagation delay time, low to high level output and 100.00 nanoseconds propagation delay time, high to low level
output
Memory Device Type:
Rom
Test Data Document:
96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).
Terminal Type And Quantity:
48 printed circuit

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N/a

Shelf Life:

Unit Of Measure:

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Demilitarization:

Yes - demil/mli

Fiig:

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